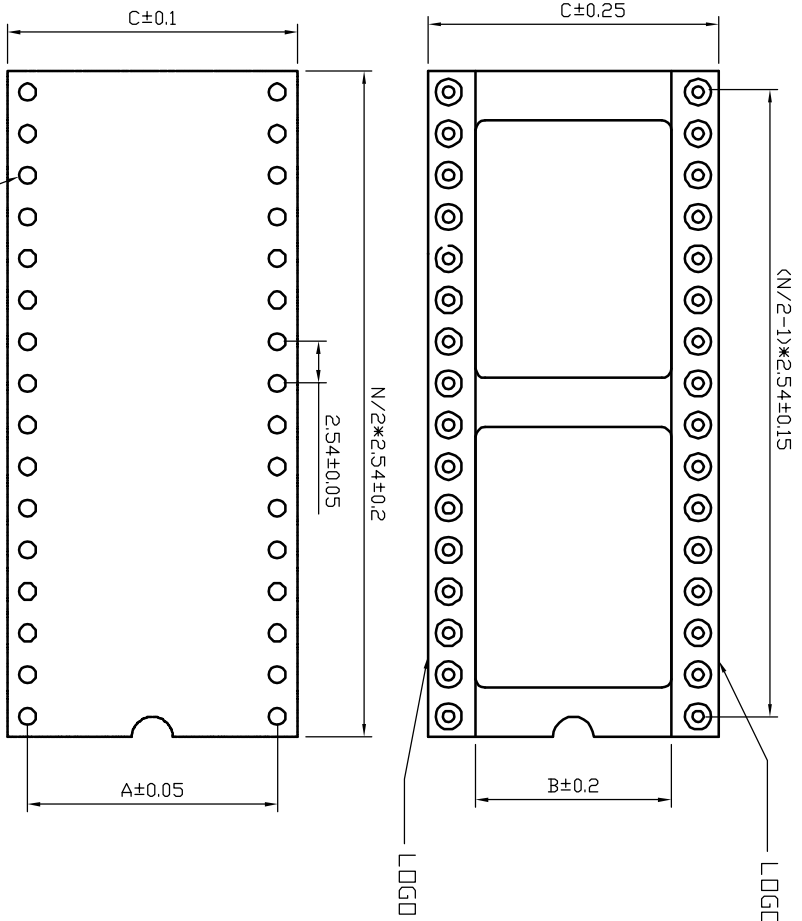


	三型	四型	六型	九型
A	7.62	10.16	15.24	22.86
B	4.14	6.68	11.76	19.38
C	10.12	12.66	17.74	25.36



PART NO.

ELECTRICAL:  
 CURRENT RATING: 3.0AMPS/CONTACT MAX.  
 CONTACT RESISTANCE: 20mΩ/CONTACT MAX.  
 INSULATION RESISTANCE: 1000MΩ AT V=100V MIN.  
 OPERATING VOLTAGE: 60V AC/DC  
 MECHANICAL:  
 AVERAGE INSERTION FORCE WITH STEEL PIN OF Ø0.43mm: 250G MAX.  
 AVERAGE WITHDRAWAL FORCE WITH STEEL PIN OF Ø0.43mm: 25G MIN.  
 MECHANICAL LIFE CYCLE: 200 CYCLE MIN.  
 OPERATING TEMPERATURES: GOLD PLATED: -55°C TD +125°C  
 TIN PLATED: -40°C TD +105°C  
 SOLDERING TEMPERATURE: PBT,+240°C,10S MAX.  
 MATERIAL  
 PIN: BRASS, MACHINED  
 CLIP: BERYLLIUM COPPER OR PHOSPHOR BRONZE  
 INSULATOR BODY(BLACK): PBT OR OTHER(UL94V-0)

Z-100 \* \* \* \* \* 0 \*

LOGO  
 0=NEXTRON LOGO  
 1=NO LOGO

NO. OF CONTACT  
 06~64=06PIN~64PIN  
 DIP SPACING  
 3=7.62mm  
 4=10.16mm  
 6=15.24mm  
 9=22.86mm  
 HOUSING TYPE  
 1=WITH BAR  
 2=WITHOUT BAR (FOR 6~16PIN ONLY)  
 PITCH  
 0=2.54mm

CODE	PIN PLATED	CLIP PLATED
1001	TIN 200μ"	GOLD FLASH
1003	TIN 200μ"	GOLD 10μ"
1005	TIN 200μ"	GOLD 30μ"
1007	TIN 200μ"	TIN 200μ"
1301	GOLD FLASH	GOLD FLASH
1303	GOLD FLASH	GOLD 10μ"
1305	GOLD FLASH	GOLD 30μ"
1307	GOLD FLASH	TIN 200μ"

PCB LAYOUT

正凌精密工业(广东)有限公司  
 2016/3/18  
 内部资料请勿复印

REV.	DESCRIPTION	DATE	BY
B	PART NO MODIFY /A=2	3/11/16	
A1	PART NO MODIFY	8/17/11	
A	NEW RELEASED	10/28/09	

UNITS	mm	INCH	NAME: 2.54mm IC SOCKET	PART NO:	TITLE:
GENERAL TOLERANCES: (UNLESS SPECIFIED)			OPEN FRAME SOLDER TYPE	Z-100*****0*	NEXTRON'S ENGINEERING CORP.
4 PLACE ±.***			APPD:	楊海文	CUSTOMER DWG
3 PLACE ±.***			2016/3/17		
2 PLACE ±0.10 ±.***			CHKD:	廖小瓊	DWG NO:
1 PLACE ±0.30 ±.***			2016/3/17		010-0000-633
ANGULAR: X°±1° X'±**			DRAWN:	陳惠枝	SCALE: SHEET: REV.:
			2016/3/17		1/1 1/1 B

A2

D-PRD-034